

L Number	Hits	Search Text	DB	Time stamp
1	304	((ptfe or poltetrafluoroethylene) and silicon) with (particles or particle or fillers or filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 12:41
3	1	("20010039300").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 12:51
2	15	((ptfe or poltetrafluoroethylene) and silicon) near (particles or particle or fillers or filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:17
8	102	(ptfe or poltetrafluoroethylene) same (PCB or PWB or (printed near board))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:14
9	166	((ptfe or poltetrafluoroethylene) with (si or silicon))and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:18
10	166	((ptfe or polytetrafluoroethylene) with (si or silicon))and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:19
11	3	((ptfe or polytetrafluoroethylene) with (si or silicon))and (chip or die)) and (pcb or pwb or (print\$2 adj board))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:22
12	119	((ptfe or polytetrafluoroethylene) with (si or silicon))and (chip or die)) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB	2003/03/10 13:30
13	1	("6388208").PN.	USPAT	2003/03/10 13:30